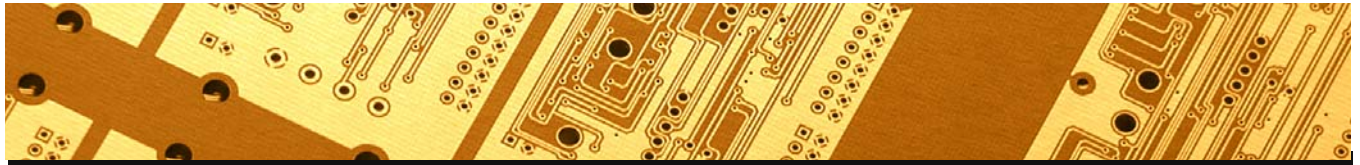


CORPORATE NEWS



MFS Technology (S) Pte Ltd Newsletter

Jan 2015

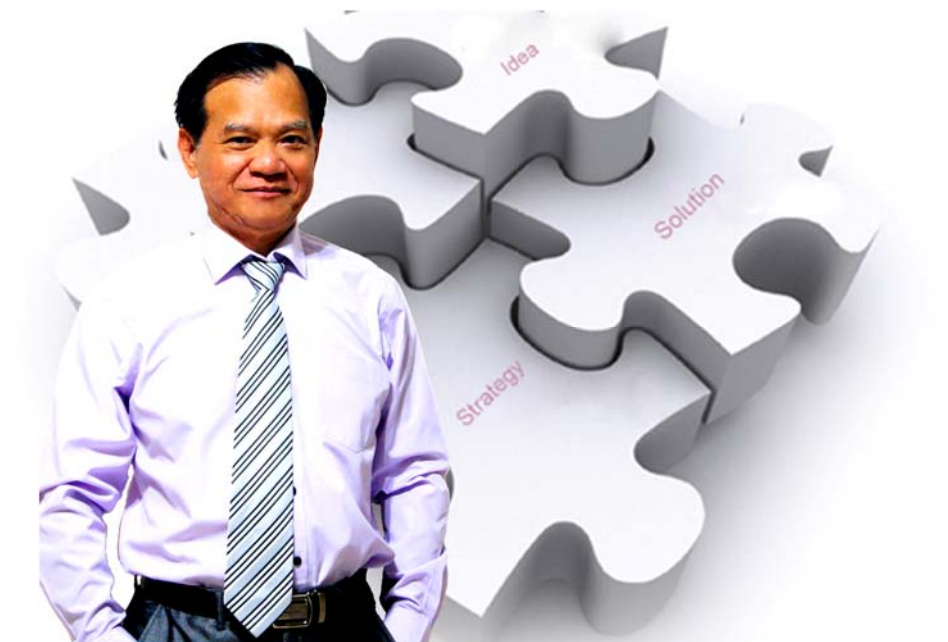
Mr. GL Cheng as MFS Chief Innovation Officer

With MFS's vision and strategic business direction to become Innovative Partner-of-Choice for Printed Circuit Applications (PCBs, FPCs, Rigid-Flex), the company has created a position for Chief Innovation Officer (CIO) to support the initiative.

Effective 1 January 2015, GL Cheng is our Chief Innovation Officer. He is responsible for exploring new technologies to develop into new products, overseeing research projects, and providing reliable technical assessments of potential mergers and acquisitions.

"MFS would like to work with any company who are having the same interest for potential collaboration. Please share your contact details, we will discuss with you and plan for the best"

*- GL Cheng
Chief Innovation Officer*



Mr. GL Cheng's photo

Chief Innovation Officer

- Effective 1st Jan 2015
- Explore new technologies
- Develop new products
- Oversee research projects
- Provide technical assessments of potential mergers & acquisitions